

Application Data Sheet

Application Information

Application Type::	Reissue
Subject Matter::	Utility
Suggested classification::	
Suggested Group Art Unit::	
CD-ROM or CD-R?::	None
Computer Readable Form (CRF)?::	No
Title::	PROCESS FOR MANUFACTURING SEMICONDUCTOR DEVICE AND SEMICONDUCTOR WAFER
Attorney Docket Number::	069974-0143
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	4C
Total Drawing Sheets::	4
Small Entity?::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Keiichiro
Family Name::	Kata

City of Residence:: Tokyo
Country of Residence:: Japan
Street of mailing address::
 Tokyo,
Country of mailing address:: Japan

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Shinichi
Family Name:: Chikaki
City of Residence:: Tokyo
Country of Residence:: Japan
Street of mailing address::
 Tokyo,
Country of mailing address:: Japan

Correspondence Information

Correspondence Customer Number:: 22428
E-Mail address:: PTOMailWashington@FoleyLaw.com

Representative Information

Representative Customer Number::	22428	
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Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	Reissue of	5,844,304	12/01/1998

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	6-237653	09/30/1994	Yes

Assignee Information

Assignee name:: NEC Corporation